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**UserID:** TThomas1

**Computer:** WS06537

**Date:** 08/26/2002

**Time:** 05:31

	Type	Hit	Search Text
1	BRS	401	monitor\$3 adj wafer
2	BRS	10191	(chemical\$2 near mechanical\$2) adj polish\$3
3	BRS	12034	CMP
4	BRS	3013	shallow adj trench adj isolation
5	BRS	3151	STI
6	BRS	66	(monitor\$3 adj wafer) and (((chemical\$2 near mechanical\$2) adj polish\$3) or CMP)
7	BRS	1	silicon adj on adj insulator
8	BRS	3058	silicon?on?insulator
9	BRS	5829	SOI
10	BRS	4	(monitor\$3 adj wafer) and ((shallow adj trench adj isolation) or STI)
11	BRS	8	(monitor\$3 adj wafer) and (silicon?on?insulator or SOI)
12	BRS	9390	etch\$3 adj stop\$3
13	BRS	1061	(etch\$3 adj stop\$3) and (silicon?on?insulator or SOI)
14	BRS	120	(etch\$3 adj stop\$3) and (silicon?on?insulator or SOI) and ((shallow adj trench adj isolation) or STI)
16	BRS	782472	test\$3
17	BRS	992451	measur\$3
18	BRS	446179	monitor\$3

	<b>DBs</b>	<b>Time Stamp</b>	<b>Comment</b>
<b>1</b>	<b>USPAT</b>	<b>2002/08/24 17:26</b>	
<b>2</b>	<b>USPAT</b>	<b>2002/08/24 17:29</b>	
<b>3</b>	<b>USPAT</b>	<b>2002/08/24 17:29</b>	
<b>4</b>	<b>USPAT</b>	<b>2002/08/24 17:29</b>	
<b>5</b>	<b>USPAT</b>	<b>2002/08/24 17:30</b>	
<b>6</b>	<b>USPAT</b>	<b>2002/08/24 17:43</b>	
<b>7</b>	<b>USPAT</b>	<b>2002/08/24 18:19</b>	
<b>8</b>	<b>USPAT</b>	<b>2002/08/24 18:19</b>	
<b>9</b>	<b>USPAT</b>	<b>2002/08/24 18:31</b>	
<b>10</b>	<b>USPAT</b>	<b>2002/08/24 18:58</b>	
<b>11</b>	<b>USPAT</b>	<b>2002/08/24 19:08</b>	
<b>12</b>	<b>USPAT</b>	<b>2002/08/24 19:09</b>	
<b>13</b>	<b>USPAT</b>	<b>2002/08/24 19:09</b>	
<b>14</b>	<b>USPAT</b>	<b>2002/08/24 19:29</b>	
<b>16</b>	<b>USPAT; US-PGPUB</b>	<b>2002/08/24 21:18</b>	
<b>17</b>	<b>USPAT; US-PGPUB</b>	<b>2002/08/24 21:19</b>	
<b>18</b>	<b>USPAT; US-PGPUB</b>	<b>2002/08/24 21:19</b>	

	Error Definition	Err rs
1		0
2		0
3		0
4		0
5		0
6		0
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8		0
9		0
10		0
11		0
12		0
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14		0
16		0
17		0
18		0

	Type	Hits	Search Text
19	BRS	1511	(test\$3 measur\$3 monitor\$3) and ((shallow adj trench adj isolation) STI)
20	BRS	547	(test\$3 measur\$3 monitor\$3) and ((shallow adj trench adj isolation) STI) and (((chemical\$2 near mechanical\$2) adj polish\$3) CMP)
21	BRS	33	((test\$3 measur\$3 monitor\$3) near (structure or wafer)) and ((shallow adj trench adj isolation) STI) and (((chemical\$2 near mechanical\$2) adj polish\$3) CMP)

	<b>DBs</b>	<b>Tim Stamp</b>	<b>Comments</b>
<b>19</b>	<b>USPAT; US-PGPUB</b>	<b>2002/08/24 21:20</b>	
<b>20</b>	<b>USPAT; US-PGPUB</b>	<b>2002/08/24 23:13</b>	
<b>21</b>	<b>USPAT; US-PGPUB</b>	<b>2002/08/24 23:14</b>	

	Error D finition	Errors
19		0
20		0
21		0